



MATERIAL: AL

UNLESS OTHERWISE SPECIFIED:		DIMENSIONS ARE IN INCHES	
DECIMALS ARE TO 0.005		ANGULAR DIMENSIONS ARE TO 0.5	
DO NOT SCALE DRAWING			
DRAWN	S. KYRE	DATE	09-21-05
CHECKED			
DESIGN			
UNIVERSITY OF CALIFORNIA @ SANTA BARBARA		HIGH ENERGY PHYSICS	
BASE PLATE FOR BACKSIDE BIAS		ENCAPSULATION TEC MODULES	
SIZE	DIRECTORY	PART NO.	REV
D	TEC	ENCAPS-02	
SCALE 1=1	SHEET	OF	